

C1812C681JZGACTU

Aliases (C1812C681JZGAC7800) SMD Comm COG HV, Ceramic, 680 pF, 5%, 2,500 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1812, 2.3 mm



General Information	
Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	87 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1812
L	4.5mm +/-0.3mm
W	3.2mm +/-0.3mm
Т	2.5mm +/-0.20mm
S	2.3mm MIN
В	0.6mm +/-0.35mm

W	3.2mm +/-0.3mm	Tolerance	5%
Т	2.5mm +/-0.20mm	Voltage DC	2500 VDC
S	2.3mm MIN	Dielectric Withstanding Voltage	3,000 VDC
В	0.6mm +/-0.35mm	Temperature Range	-55/+125°C
		Temp. Coefficient	COG
Packaging Specifications		Capacitance Change with	30 ppm/C, 1MegaHz 1.0Vrms
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
Packaging Quantity	500	Dissipation Factor	0.1% 1 MHz 1.0Vrms

Specifications

Capacitance	680 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	2500 VDC
Dielectric Withstanding Voltage	3,000 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with	30 ppm/C, 1MegaHz 1.0Vrms
Reference to +25°C and 0 VDC Applied (TCC)	30 ppiny c, ilviegal iz i.o vims
	O.1% 1 MHz 1.0Vrms
Applied (TCC)	., , , ,

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Generated 07/19/2025 © 2006 - 2025 YAGEO